ENDOTHERM

Product : NO-CLEAN SOLDER PASTE ALLOY: Sn63-Pb37

PRODUCT DESCRIPTION

Formula Sn63-Pb37 is a mildly activated resin-based formulation designed specifically to allow post-process residues to be left on the PCB without degradation. Sn63-Pb37 has a wide process window uncommon to most non-clean solder pastes, which allows it to accommodate a variety of environments and process applications. Sn63-Pb37 performs well in continuous production, offering good slump resistance, high tack, and low post-process residues. The post soldering residues are compatible with ICT (In Circuit Testing). Sn63-Pb37 is a solder paste formula that maintains its activity and printing characteristics for up to 8 hours.

APPLICATION

The product is applied to between standard moulding board print and fine pitch one. The print speed is suggested to be $20 \sim 100$ mm/sec.The moulding board thickness is 0.1 mm ~ 0.2 mm,

The scraper pressure is $1 \sim 10 \text{kg/cm}^2$.

Application conditions: Temperature: 25±3°CRH≤65%.

FEATURES

Alloying component: Sn63-Pb37 Powder size: Type 3(25~45µm) Alloying powder component: 89.5±0.3wt% Residue: about 5wt% Packaging: 500g per bottle

SAFETY

Sn63-Pb37 will produce some reacting or compound broken down gas in the process of solder reflowing. Therefore, It's suggested that there are good atmospheric conditions in the work area.

STORE

Sn63-Pb37 has a refrigerated shelf life of 6 months at 3-10°C. Sn63-Pb37 packaged in syringes must be refrigerated in order to avoid material separation. Do not freeze this product.

• Allow the solder paste to warm completely and naturally to ambient temperature (4 hours is recommended) prior to breaking the seal for use.

• Refrigeration may result in the separated materials of solder paste. Thoroughly mix the product for 3 to 6 minutes for manual mixing and 2-3 minutes for machine mixing before application.

• Do not store new and used paste in the same container. Re-seal any opened containers while not in use. As the cap of the 500 gram jars is not a seal, replace the internal plug in conjunction with the cap to ensure the best possible seal.



NOTE:

The above temperature curve is considered to be a recommended technology one for reference. It can be adjusted due to actual technology demand.

TECHNICAL DATA SHEET

| Test item | Result | Standard reference/Notes |
|---|--|--|
| Chemical characteristic | | |
| Reactive grade | ROL1 | IPC J-STD-004 |
| Halogen content | 0.014% | IPC J-STD-004 |
| Bronze mirror test | PASS | IPC J-STD-004 |
| Bronze board erode test | PASS | IPC J-STD-004 |
| Electrical capability | | |
| SIR (IPC, 7days @85°C /85%RH) | PASS, >1.8×10 ⁹ ohms | IPC J-STD-004 (Pass means ≥ 1.0×10 ⁸ ohms) |
| SIR (Bellcore, 96 hours @65℃ /85%RH) | PASS, >3.7×10 ¹² ohms | $\begin{array}{c} \text{Bellcore GR78-CORE} \\ \text{(Pass means } \geq 1.0 \times 10^{11} \text{ohms)} \end{array}$ |
| Electromigration (Bellcore, @65℃/85%RH 10v 500hours) | PASS initial = 3.65×10^{10} ohms final = 1.42×10^{10} ohms | Bellcore GR78-CORE (Pass means final>initial/10) |

| Physics cap | ability | | | | | | | | | |
|------------------------------|--------------|-------|---|-------------------------------------|---------------|--|---------|--------|--------|-----|
| Colour | | | | Limpidity 1 | flux residue | | | | | |
| Adhesive for (time = 8hou | | у | PASS, @25°C/75%RH, change<1g/mm ² | | | | IPC J-S | TD-005 | | |
| | | | | PASS, @25°C/50%RH, variation<10% | | | | JIS Z | 3284 | |
| Viscosity | | | 170±30 Pa·S | | | @ 10 RPM (Malcom Viscometer @ 25°C) | | | C) | |
| Solder ball | | | Acceptable | | | IPC J-STD-005 | | | | |
| Holding time | of viscosity | | > 8 hours | | @ 50%RH, 22°C | | | | | |
| Coverage | Coverage | | | PASS | | | | JIS Z | 3197 | |
| Slump | | | PASS | | | IPC J-S | TD-005 | | | |
| Alloy (wt%) | Sn | Sb | Bi | Cu | Ag | Fe | Zn | Cd | AI | Pb |
| , | 62.5~63.5 | <0.20 | <0.10 | <0.08 | <0.10 | <0.02 | <0.001 | <0.002 | <0.001 | Rem |

MATERIAL SAFETY DATA SHEET

SECTION 1 - CHEMICAL PRODUCT AND COMPANY INFORMATION

Product Identifier : Sn63-Pb37 SOLDER PASTE

Product Use : Mixture of solder powder with paste flux for soldering electrical or electronic connections.

SECTION 2 - COMPOSITION / INFORMATION ON INGREDIENTS

| Name | CAS # | Weight percent | OSHA PEL mg/m ³ | TLV-TWA mg/m ³ | TLV-STEL mg/m ³ |
|----------------|-----------|----------------|----------------------------|---------------------------|----------------------------|
| Tin | 7440-31-5 | 56~57 | 2.0 | 2.0 | N.E. |
| Lead | 7439-92-1 | 33~34 | 0.05 | 0.15 | N.E. |
| Modified rosin | 8050-09-7 | 3.0-4.5 | N.E. | N.E. | N.E. |
| Confidential | * | 2.0-6.0 | N.E. | N.E. | N.E. |

| nhalation | Flux fumes during soldering may cause irritation and damage of mucous membranes and respiratory system. |
|-----------------|---|
| Eye Contact | Irritation from contact with smoke from soldering. |
| Skin Contact | Possible local irritation by contact with flux or fumes. |
| Ingestion | May be harmful if swallowed. Most of the solder paste will pass through the body unabsorbed. |
| Skin Absorption | None. |

Fumes and/or dusts produced by this product may be hazardous in case of ingestion, of inhalation. This product may be hazardous in case of skin contact (irritant, sensitizer), of eye contact (irritant).

Medical Conditions Aggravated by Overexposure

Chemical hypersensitivity, asthma and other respiratory conditions, existing eye and skin disorders.

Overexposure /Signs/Symptoms

Not available.

See Toxicological Information (section 11)

Notes: The ENDOTHERM does not recommend, manufacture market or endorse any of its products for human consumption.

SECTION 4 - FIRST AID MEASURES

Seek medical assistance for further treatment, observation and support if needed.

EYE CONTACT

Flush eyes with plenty of water and get medical attention.

SKIN CONTACT

Prolonged and repeated contact with bare skin may cause irritation. Wash gently and thoroughly the contaminated skin with running water and non-abrasive soap.

INHALATION

Remove person from exposure to fumes.

INGESTION

Remove dentures if any. Have conscious person drink several glasses of water or milk. INDUCE VOMITING by sticking finger in throat. Lower the head so that the vomit will not reenter the mouth and throat. NEVER give an unconscious person anything to ingest. Seek medical attention.

| SECTION 5 - FIRE FIGHTING MEASURES | |
|--|---|
| Flammability | :Yes \bigcirc No \odot |
| Flash Point (T.O.C) | : N.E. |
| Auto-Ignition Temperature | : N.E. |
| Flammability Limits percent by volume in air | : N.E. |
| Extinguishing Means | : Water \bigcirc Carbon Dioxide \odot Alcohol \odot Foam \bigcirc Dry Chemical \bigcirc |
| Hazardous Combustion Products | : Carbon monoxide,carbon dioxide |
| Explosion Sensitivity | : Impact - None Identified |
| Static Discharge Sensitivity | : Yes \bigcirc No \odot |
| Special Firefighting Procedures | : Avoid breathing smoke. Wear self-contained breathing apparatus if this material is in the vicinity of a fire. |

SECTION 6 - ACCIDENTAL RELEASE MEASURES

Spill or Leak Procedures

Using a spatula, scoop up paste and place in a plastic or glass jar and tightly cap.Remove traces of paste residue using cloth rags or paper towels moistened with ethyl or isopropyl alcohol.

SECTION 7 - HANDLING AND STORAGE

Storage Precautions

Store at 3 -10°C in closed containers. Store in a dry place.

Handling Precautions

Keep containers sealed when not in use.

Personal Precautions

Wash hands after handling solder paste and before eating or smoking. Care should be taken to remove solder paste from under fingernails.

SECTION 8 - EXPOSURE CONTROLS, PERSONAL PROTECTION

Engineering Controls

Use process enclosures, local exhaust ventilation, or other engineering controls to keep airborne levels below recommended exposure limits. If user operations generate dust, fume or mist, use ventilation to keep exposure to airborne contaminants below the exposure limit.

Personal Protection

| Eyes | Safety glasses or goggles should be used |
|-------------------------|--|
| Body | Lab coat |
| Respiratory | When ventilation is not sufficient to remove fumes from the breathing zone, a safety approved respirator or self-contained breathing apparatus should be worn. |
| Hands | Wear rubber or cloth gloves to avoid skin contact |
| Feet | Not applicable |
| Hygienic Work Practices | Wash hands thoroughly after handling chemicals. |

Note:

Suggested protective clothing may not be adequate for a specific process. Consult a specialist before using.

| SECTION 10 - STABILITY AN | D REACTIVITY | | | |
|--|------------------------------------|--------------------------------|-----------------|--|
| Spill or Leak Procedures | Stable \bigcirc Unstable \odot | Spill or Leak Procedures | Not Established | |
| Incompatibility with Various Substances | Reactive with oxidizing age | Reactive with oxidizing agents | | |
| Hazardous Decomposition | Not Established | | | |
| Corrosivity | Not Applicable | | | |

SECTION 11 - TOXICOLOGICAL INFORMATION

Toxic and Chronic Effects on Humans

Fumes and/or dusts produced by this product may be hazardous in case of ingestion, of inhalation. This product may be hazardous in case of skin contact (irritant, sensitizer), of eyecontact (irritant).

CARCINOGENIC EFFECTS: [LEAD] - Classified A3 (Proven for animal) by ACGIH, 2B (Possible for human) by IARC. MUTAGENIC EFFECTS: Not available.

TERATOGENIC EFFECTS: [LEAD] - Classified 1 by European Union.

DEVELOPMENTAL TOXICITY: [LEAD] - Classified Reproductive system/toxin/female, Reproductive system/toxin/male [PROVEN]. The product may be toxic to blood, kidneys, lungs, the nervous system, the reproductive system, spleen, brain, digestive system, gastrointestinal tract, upper respiratory tract, skin, central nervous system (CNS), eye, lens or cornea, thyroid. Repeated or prolonged exposure to the substance can produce target organs damage. Repeated exposure to toxic material may produce general deterioration of health by an accumulation in one or many human organs.

| This section is subject to | future development. | |
|--|------------------------|--|
| Biodegradability | Data not established | |
| | | |
| Aquatic Toxicity | Data not established | |
| SECTION 13 - DISPOSA | L CONSIDERATIONS | |
| SECTION 13 - DISPOSA Waste Disposal Metho | L CONSIDERATIONS ds | |
| Waste Disposal Metho Solder paste can be melt | L CONSIDERATIONS | |

| DOT Classification | Not a DOT controlled material (United States). |
|------------------------|--|
| ADR/RID Classification | Not controlled under ADR (Europe). |
| TDG Classification | Not controlled under TDG (Canada). |

| SECTION 15 – REG | ULATORY INFORMATION |
|------------------|--|
| U.S.A. | All Chemical substances in this product are listed in the EPA (Environmental Protection Agency) TSCA (Toxic Substances Control Act) Inventory.B2 D2B |
| Europe | European Council Directive 67/548/EEC |

Note:

To the best of our knowledge, the information contained herein is accurate. However, neither the above Named supplier nor any of its subsidiaries assumes any liability whatsoever for the accuracy or completeness of the information contained herein. Final determination of suitability of any material is the sole responsibility of the user. All materials may present unknown hazards and should be used with caution. Although certain hazards are described herein, we cannot guarantee that these are the only hazards that exist All right